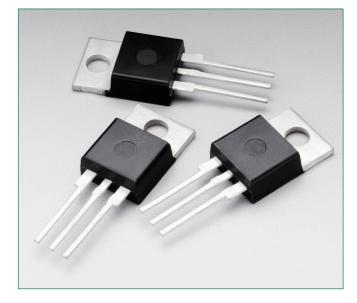
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Thyristors

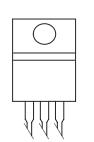
Surface Mount - 600V - 800V > MCR8NG

MCR8NG



Pin Out





Description

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

Po

Features

- Blocking Voltage of 600 thru 800 Volts
- On-State Current Rating of 8 Amperes RMS at 80°C
- High Surge Current Capability 80 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/sec Minimum at 125°C
- These are Pb-Free Devices

Functional Diagram



Additional Information









Surface Mount - 600V - 800V > MCR8NG

Maximum Ratings ($T_{J} = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) (– 40 to 1125°C, Sine Wave, 50 to 60 Hz, Gate Open) MCR8MG		600 800	V
On-State RMS Current (180° Conduction Angles; $T_c = 80°C$)	I _{T (RMS)}	8.0	А
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, T _c = 125°C)	I _{TSM}	80	A
Circuit Fusing Consideration (t = 8.3 ms)	l²t	26.5	A ² sec
Forward Peak Gate Power (Pulse Width \leq 1.0 $\mu s, T_c$ = 80°C)	P _{GM}	5.0	W
Forward Average Gate Power (t = 8.3 ms, $T_c = 80^{\circ}C$)	P _{GM (AV)}	0.5	W
Forward Peak Gate Current (Pulse Width \leq 1.0 $\mu s, T_c$ = 80°C)	I _{GM}	2.0	А
Operating Junction Temperature Range	Т	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics						
Rating		Symbol	Value	Unit		
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R _{sjc} R _{sja}	2.2 62.5	°C/W		
Maximum Lead Temperature for Solo 10 seconds	TL	260	°C			



Surface Mount - 600V - 800V > MCR8NG

Electrical Characteristics \cdot **OFF** (T₁ = 25°C unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T _J = 25°C	I _{DRM} ,	-	-	0.01	μA
$(V_{D} = V_{DRM} = V_{RRM}; Gate Open)$	T _J = 125°C	I _{RRM}	-	-	2.0	mA

Electrical Characteristics - **ON** ($T_J = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak On-State Voltage (I _{TM} = 16 A)		-	-	1.8	V
Gate Trigger Current (Continuous dc) ($V_D = 12 V$, $R_L = 100 \Omega$)		2.0	7.0	15	mA
Gate Trigger Voltage (Continuous dc) (V $_{\rm D}$ = 12 V, R $_{\rm L}$ = 100 $\Omega)$		0.5	0.65	1.0	V
Gate Non–Trigger Voltage ($V_D = 12 \text{ V}, T_J = 125^{\circ}\text{C}, R_L = 100 \Omega$)		0.2	-	-	V
Holding Current ($V_{D} = 12$ V, Gate Open, Initiating Current = 200 mA)		4.0	17	30	mA
Latch Current ($V_{D} = 12$ V, $I_{G} = 15$ mA)		6.0	20	40	mA

Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate of Rise of Off–State Voltage ($V_D = Rated V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^{\circ}C$)		100	250	_	V/µs
Critical Rate of Rise of On–State Current (IPK = 50 A, Pw = 40 sec, diG/dt = 1 A/sec, Igt = 50 mA		-	_	50	A/ms

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Indicates Pulse Test: Pulse Width ::; 2.0 ms, Duty Cycle ::; 2%.



Surface Mount - 600V - 800V > MCR8NG

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{drm}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

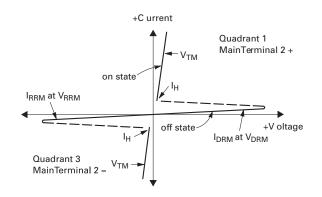
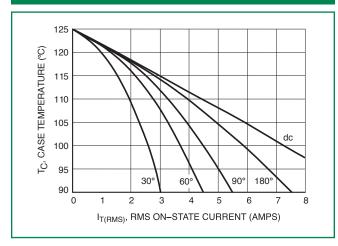
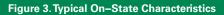


Figure 1. Typical RMS Current Derating





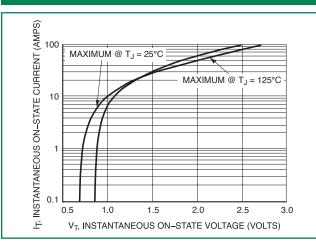


Figure 2. On–State Power Dissipation

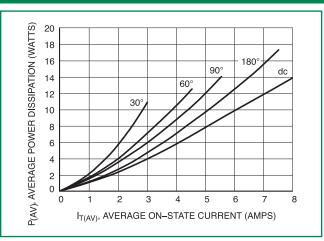
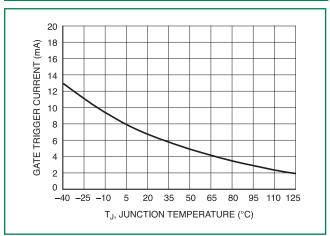


Figure 4. Typical Gate Trigger Current vs Junction Temperature





Surface Mount - 600V - 800V > MCR8NG

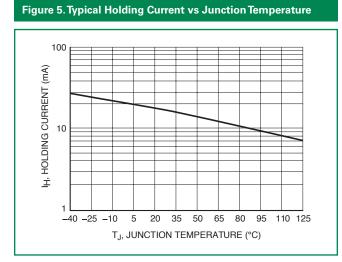


Figure 7. Typical Latching Current vs Junction Temperature

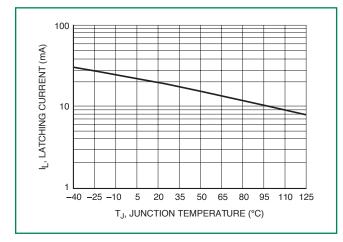
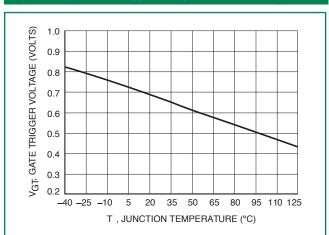


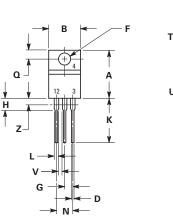
Figure 6. Typical Gate Trigger Voltage vs Junction Temperature

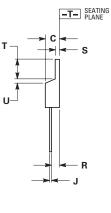




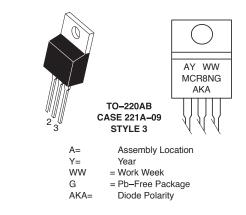
Surface Mount - 600V - 800V > MCR8NG

Dimensions





Part Marking System



Pin Assignment	
1	Cathode
2	Anode
3	Gate
4	Anode

Ordering Information

Device	Package	Shipping
MCR8NG	TO-220AB (Pb-Free)	50 Units/ Rail

	Incl	nes	Millimeters	
Dim	Min	Max	Min	Max
А	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

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